

Recording/Playback Equalizer Amplifier

Description

The CXA1998AQ is an IC developed for analog signal processing in tape recorders. Processing for both the recording and playback systems is achieved on one chip.

Features

- 11-bit serial data interface
- Recording/playback mute function
- Recording equalizer Gp and Fp can be adjusted externally.
- AGC (Automatic Gain Control)
- Comparator for AMS (Automatic Music Sensor)
- Recording/playback equalizer amplifier with 1.7 times speed switching

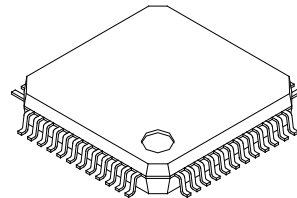
Absolute Maximum Ratings (Ta = 25°C)

| | | | |
|-------------------------------|-----------------------------------|-------------|----|
| • Supply voltage | V _{CC} , V _{DD} | 12 | V |
| • Operating temperature | T _{opr} | -20 to +75 | °C |
| • Storage temperature | T _{stg} | -65 to +150 | °C |
| • Allowable power dissipation | P _D | 645 | mW |

Operating Conditions

| | | | |
|----------------|-----------------|-------------|---|
| Supply voltage | V _{CC} | 6.5 to 10.0 | V |
| | V _{DD} | 4.5 to 5.5 | V |

48 pin QFP (Plastic)



Structure

Bipolar silicon monolithic IC

Applications

All analog signal processing in the cassette decks of tape recorders and compact music centers

Applicable Head

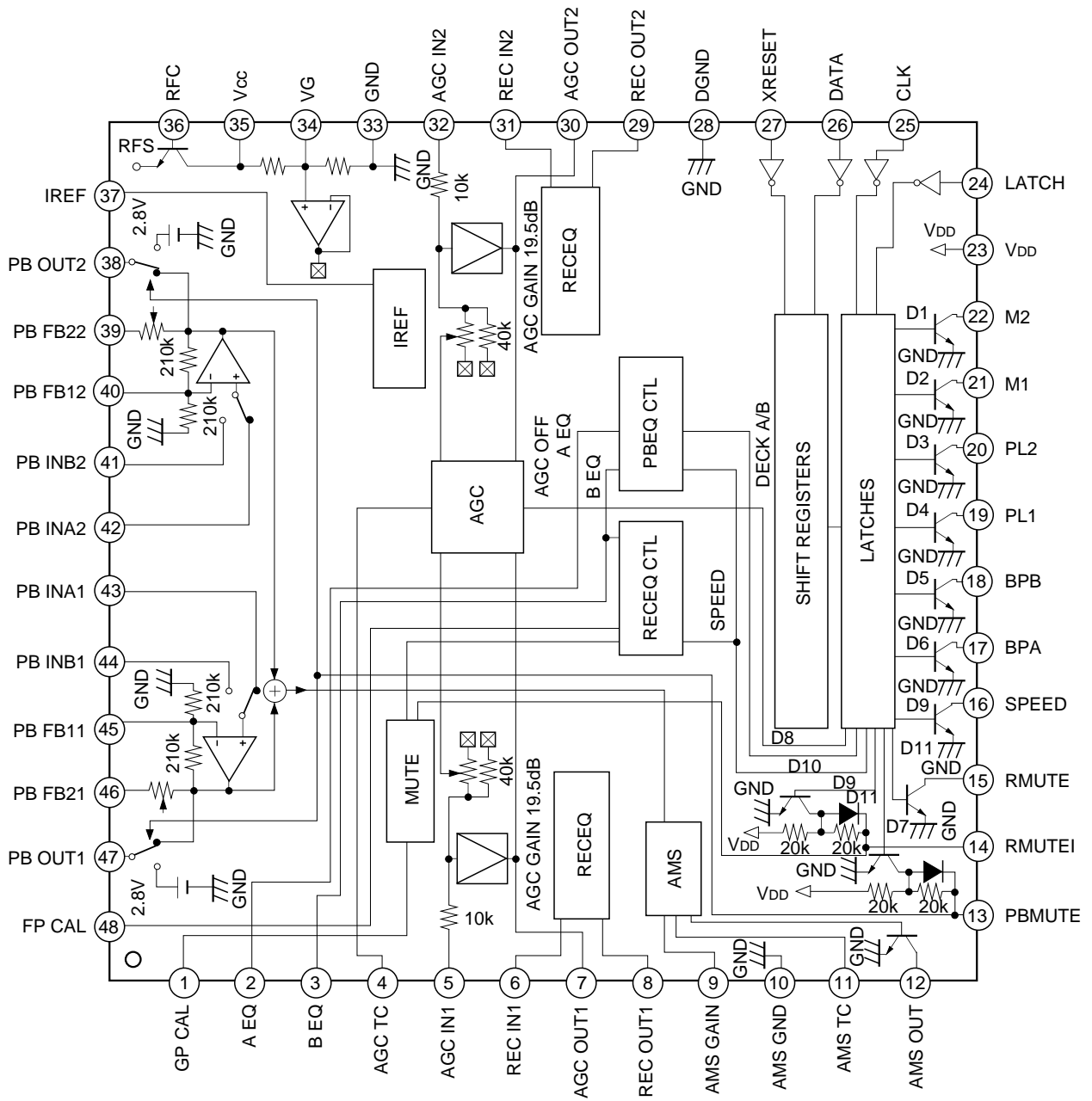
Applicable to MITSUMI ELECTRIC Co., Ltd.

Playback head: BP-7442-CP-6973

Recording/playback head: BC-9242-CB-9267

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Block Diagram and Pin Configuration (Top View)



Pin Description

(Ta = 25°C, Vcc = 8V, VDD = 5V, no signal, RESET ON)

| Pin No. | Symbol | DC voltage | I/O | I/O resistance | Equivalent circuit | Description |
|---------|--------|-------------|-----|----------------|--------------------|---|
| 1 | GP CAL | 1.2V | — | — | | Connects a resistor for determining the high-band peak gain of recording equalizer. Reference setting resistance is 27kΩ. |
| 2 | A EQ | — | I | — | | Deck A equalizer switch. Low: 120μs EQ High: 70μs EQ |
| 3 | B EQ | 2.5V (OPEN) | I | 53kΩ | | Deck B equalizer switch. Low: NORMAL TAPE, 120μs EQ Medium: Cro2 TAPE, 70μs EQ High: METAL TAPE, 70μs EQ |
| 4 | AGC TC | 0.0V | — | — | | Connects a resistor and capacitor for determining AGC attack/recovery time constants. |

| Pin No. | Symbol | DC voltage | I/O | I/O resistance | Equivalent circuit | Description |
|---------|----------------------|------------|-----|----------------|--------------------|---|
| 5 32 | AGC IN1 AGC IN2 | 4.0V | I | 50kΩ | | AGC signal input. Input resistance changes between 50kΩ and 100kΩ. AGC functions when the signal of -30dBm or more is input to AGC for AGC ON. (External 47μF//300kΩ for Pin 4) |
| 6 31 | REC IN1 REC IN2 | 4.0V | I | 50kΩ | | Recording equalizer input. |
| 7 30 | AGC OUT1 AGC OUT2 | 4.0V | O | 147Ω | | AGC output. |
| 8 29 | REC OUT1 REC OUT2 | 4.0V | O | 147Ω | | Recording equalizer output. |

| Pin No. | Symbol | DC voltage | I/O | I/O resistance | Equivalent circuit | Description |
|---------|----------|------------|-----|----------------|--------------------|---|
| 9 | AMS GAIN | 3.5V | — | — | | Connects a resistor for determining AMS signal detection level and a capacitor for determining HPF cut-off frequency. |
| 10 | AMS GND | 0.0V | — | — | | AMS block ground. |
| 11 | AMS TC | 8.0V | — | — | | Connects time constant for AMS detection. |
| 12 | AMS OUT | 8.0V | O | — | | AMS output. No signal detection: High Signal detection: Low |

| Pin No. | Symbol | DC voltage | I/O | I/O resistance | Equivalent circuit | Description |
|---------|--------|------------|-----|----------------|--------------------|--|
| 13 | PBMUTE | 5.0V | — | — | | Connects a capacitor for setting time constant for playback mute ON/OFF switching. |
| 14 | RMUTE1 | | | | | Connects a capacitor for setting time constant for recording mute ON/OFF switching. |
| 15 | RMUTE | 5.0V | O | — | | Output for recording mute ON/OFF switch control signal. Outputs D11 from Pin 26 (DATA). |
| 16 | SPEED | | | | | Output for recording/playback equalizer speed switch control signal. Outputs D9 from Pin 26 (DATA). Low: Normal Speed High: High Speed (1.7 times) |
| 17 | BPA | 5.0V | O | — | | Outputs D6 from Pin 26 (DATA). |
| 18 | BPB | | | | | Outputs D5 from Pin 26 (DATA). |
| 19 | PL1 | | | | | Outputs D4 from Pin 26 (DATA). |
| 20 | PL2 | | | | | Outputs D3 from Pin 26 (DATA). |
| 21 | M1 | | | | | Outputs D2 from Pin 26 (DATA). |
| 22 | M2 | | | | | Outputs D1 from Pin 26 (DATA). |
| 23 | VDD | 5.0V | — | — | | Power supply of serial data interface block. |

| Pin No. | Symbol | DC voltage | I/O | I/O resistance | Equivalent circuit | Description |
|---------|--------|------------|-----|----------------|--------------------|--|
| 24 | LATCH | — | I | — | | Serial data interface latch input. |
| 27 | XRESET | | | | | Serial data interface reset input. Low: Reset. At this time serial data outputs (Pins 15 to 22) are all open (high). |
| 25 | CLK | — | I | — | | Serial data interface clock input. |
| 26 | DATA | | | | | Serial data interface serial data input. |
| 28 | DGND | 0.0V | — | — | | Serial data interface block ground. |
| 33 | GND | 0.0V | — | — | | Ground. |
| 34 | VG | 4.0V | — | 60kΩ | | Signal reference voltage. Connects a capacitor for ripple rejection. |
| 35 | Vcc | 8.0V | — | — | | Power supply. |

| Pin No. | Symbol | DC voltage | I/O | I/O resistance | Equivalent circuit | Description |
|----------|--------------------|------------|-----|----------------|--------------------|--|
| 36 | RFC | 8.0V | — | — | | Connects a resistor and capacitor for obtaining stable voltage with power supply ripple rejected. |
| 37 | IREF | 1.2V | — | — | | Connects a resistor (12kΩ) for determining equalizer gains. |
| 48 | FP CAL | | | | | Connects a resistor for determining the high-band peak frequency of recording equalizer. Reference setting resistance is 27kΩ. |
| 38 47 | PB OUT2 PB OUT1 | 2.8V | O | 147Ω | | Playback equalizer output. |
| 39 46 | PB FB22 PB FB21 | 2.8V | — | — | | Connects a capacitor for determining playback equalizer time constants, such as 120μs and 70μs. |

| Pin No. | Symbol | DC voltage | I/O | I/O resistance | Equivalent circuit | Description |
|----------------------|--|------------|-----|----------------|--------------------|---------------------------------------|
| 40 45 | PB FB12 PB FB11 | 1.4V | — | 105kΩ | | Playback equalizer negative feedback. |
| 41 42 43 44 | PB INB2 PB INA2 PB INA1 PB INB1 | 0.0V | I | 70kΩ | | Playback equalizer input. |

Note)

- AMS GND (Pin 10), DGND (Pin 28) and GND (Pin 33) are each independent in the IC and are not connected. Be sure to ground each of the ground pins listed above.
- The resistance of open collector outputs (Pins 15 to 22) can be connected to Vcc.

Electrical Characteristics

(Ta = 25°C, Vcc = 8.0V, VDD = 5.0V, refer to Electrical Characteristics Measurement Circuit)

| Item | | Measurement conditions | Min. | Typ. | Max. | Unit |
|------------------------------------|--|---|-------|-------|-------|------|
| Operating voltage | | Vcc | 6.5 | 8.0 | 10.0 | V |
| | | VDD | 4.5 | 5.0 | 5.5 | V |
| Current consumption | | Sum of Vcc and VDD pin currents NORM – NS, no signal | 13.5 | 19.7 | 25.0 | mA |
| AGC | AGC ON output level | Pin 4 external R300kΩ//C47μF f = 1kHz, Vin = -25dBm | -13.0 | -11.0 | -9.0 | dBm |
| | AGC ON channel balance | Pin 4 external R300kΩ//C47μF f = 1kHz, Vin = -25dBm | -2.0 | 0.0 | 2.0 | dB |
| | AGC ON distortion | Pin 4 external R300kΩ//C47μF f = 1kHz, Vin = 0dBm | — | 0.3 | 1.5 | % |
| | AGC OFF output level | Pin 4 external R300kΩ//C 47μF f = 1kHz, Vin = -25dBm | -7.5 | -5.5 | -3.5 | dBm |
| AMS | No signal detection threshold level | Pin 9 external R9.1kΩ, C0.015μF Pin 11 external R100kΩ//C0.1μF f = 5kHz, 0dB = -21dBm (at PBEQ reference output level) | -11.5 | -8.2 | — | dB |
| Playback equalizer amplifier block | 120μs – NS frequency response | f = 315Hz, Vin = -70dBm Reference for frequency response | -23.0 | -21.0 | -19.0 | dBm |
| | 120μs – NS frequency response | f = 2.7kHz, Vin = -58.5dBm at 120μs – NS, 315Hz | -0.1 | 1.3 | 2.9 | dB |
| | 70μs – NS frequency response | f = 4.5kHz, Vin = -53.8dBm at 120μs – NS, 315Hz | -0.1 | 1.7 | 2.9 | |
| | 120μs – HS frequency response | f = 5.3kHz, Vin = -52.5dBm at 120μs – NS, 315Hz | 1.8 | 3.0 | 4.8 | |
| | 70μs – HS frequency response | f = 9.1kHz, Vin = -47.8dBm at 120μs – NS, 315Hz | 2.1 | 3.6 | 5.1 | |
| | Signal handling | 120μs – NS, RL = 2.7kΩ f = 1kHz, THD + N = 1% | -10.0 | -6.0 | — | |
| | Total harmonic distortion | 120μs – NS, RL = 2.7kΩ f = 1kHz, Vin = -56.4dBm | — | 0.3 | 0.7 | % |
| | S/N ratio | 120μs – NS, Rg = 470Ω “A” weighting filter | 55.0 | 62.0 | — | dB |
| | Output offset voltage | 120μs – NS, Rg = 470Ω, playback mute OFF | 2.4 | 2.7 | 3.2 | V |
| | Playback mute characteristics | 120μs – NS, f = 1kHz, Vin = -51.4dBm | — | -100 | -80 | dB |

| Item | | Measurement conditions | Min. | Typ. | Max. | Unit |
|-------------------------------------|---|---|-------|-------|-------|------|
| Recording equalizer amplifier block | Reference input level | NORM – NS, 315Hz, input level at which reference output can be obtained | -28.2 | -26.7 | -25.2 | dBm |
| | Reference output level | NORM – NS, 315Hz | — | -10.0 | — | |
| | Channel balance | NORM – NS, 315Hz, output level difference 1ch-2ch for -26.7dBm input | -1.5 | 0.0 | 1.5 | dB |
| | NORM – NS frequency response | f = 3kHz at NORM – NS, 315Hz, reference output -20dB | -1.8 | -0.6 | 0.6 | |
| | NORM – NS frequency response | f = 8kHz at NORM – NS, 315Hz, reference output -20dB | 3.4 | 5.2 | 7.0 | |
| | NORM – NS frequency response | f = 12kHz at NORM – NS, 315Hz, reference output -20dB | 8.7 | 11.7 | 14.7 | |
| | CrO ₂ – NS frequency response | f = 3kHz at NORM – NS, 315Hz, reference output -20dB | 3.7 | 4.9 | 6.1 | |
| | CrO ₂ – NS frequency response | f = 8kHz at NORM – NS, 315Hz, reference output -20dB | 9.9 | 11.4 | 12.9 | |
| | CrO ₂ – NS frequency response | f = 12kHz at NORM – NS, 315Hz, reference output -20dB | 14.8 | 17.6 | 20.4 | |
| | METAL – NS frequency response | f = 3kHz at NORM – NS, 315Hz, reference output -20dB | 4.7 | 5.9 | 7.1 | |
| | METAL – NS frequency response | f = 8kHz at NORM – NS, 315Hz, reference output -20dB | 8.7 | 10.2 | 11.7 | |
| | METAL – NS frequency response | f = 12kHz at NORM – NS, 315Hz, reference output -20dB | 12.9 | 15.2 | 17.5 | |
| | NORM – HS frequency response | f = 5kHz at NORM – NS, 315Hz, reference output -20dB | -1.6 | 0.2 | 2.2 | |
| | NORM – HS frequency response | f = 15kHz at NORM – NS, 315Hz, reference output -20dB | 7.6 | 9.7 | 11.8 | |
| | NORM – HS frequency response | f = 20kHz at NORM – NS, 315Hz, reference output -20dB | 11.9 | 14.9 | 17.4 | |
| | CrO ₂ – HS frequency response | f = 5kHz at NORM – NS, 315Hz, reference output -20dB | 5.2 | 6.4 | 7.6 | |
| | CrO ₂ – HS frequency response | f = 15kHz at NORM – NS, 315Hz, reference output -20dB | 14.1 | 16.2 | 18.3 | |
| | CrO ₂ – HS frequency response | f = 20kHz at NORM – NS, 315Hz, reference output -20dB | 16.7 | 19.7 | 22.7 | |
| | METAL – HS frequency response | f = 5kHz at NORM – NS, 315Hz, reference output -20dB | 6.8 | 8.0 | 9.2 | |
| | METAL – HS frequency response | f = 15kHz at NORM – NS, 315Hz, reference output -20dB | 13.7 | 15.5 | 17.3 | |
| METAL – HS frequency response | f = 20kHz at NORM – NS, 315Hz, reference output -20dB | 16.9 | 19.4 | 21.9 | | |

| | Item | Measurement conditions | Min. | Typ. | Max. | Unit |
|-------------------------------------|--------------------------------|--|------|------|----------|------|
| Recording equalizer amplifier block | Signal handling | NORM – NS, $R_L = 2.7k\Omega$ $f = 1kHz$, THD + N = 1% | 8.0 | 8.8 | — | dB |
| | Total harmonic distortion | NORM – NS, $R_L = 2.7k\Omega$ $f = 1kHz$, 0dB | — | 0.2 | 0.5 | % |
| | S/N ratio | NORM – NS, $R_g = 5.1k\Omega$ “A” weighting filter | 57.0 | 60.6 | — | dB |
| | Output offset voltage | NORM – NS | 3.6 | 4.0 | 4.4 | V |
| | Recording mute characteristics | NORM – NS, $f = 1kHz$ 8dB | — | -100 | -80 | dB |
| | Control voltage low level 1 | A-EQ (Pin 2) | 0.0 | — | 0.5 | V |
| | Control voltage high level 1 | A-EQ (Pin 2) | 2.5 | — | V_{CC} | |
| | Control voltage low level 2 | B-EQ (Pin 3) | 0.0 | — | 0.5 | |
| | Control voltage medium level 1 | B-EQ (Pin 3) | 2.2 | — | 2.8 | |
| | Control voltage high level 2 | B-EQ (Pin 3) | 4.2 | — | V_{CC} | |

Note) NORM – NS: NORMAL TAPE – NORMAL SPEED

NORM – HS: NORMAL TAPE – HIGH SPEED

CrO₂ – NS: CrO₂ TAPE – NORMAL SPEED

CrO₂ – HS: CrO₂ TAPE – HIGH SPEED

METAL – NS: METAL TAPE – NORMAL SPEED

METAL – HS: METAL TAPE – HIGH SPEED

120 μ s – NS: EQ = 120 μ s – NORMAL SPEED

120 μ s – HS: EQ = 120 μ s – HIGH SPEED

70 μ s – NS: EQ = 70 μ s – NORMAL SPEED

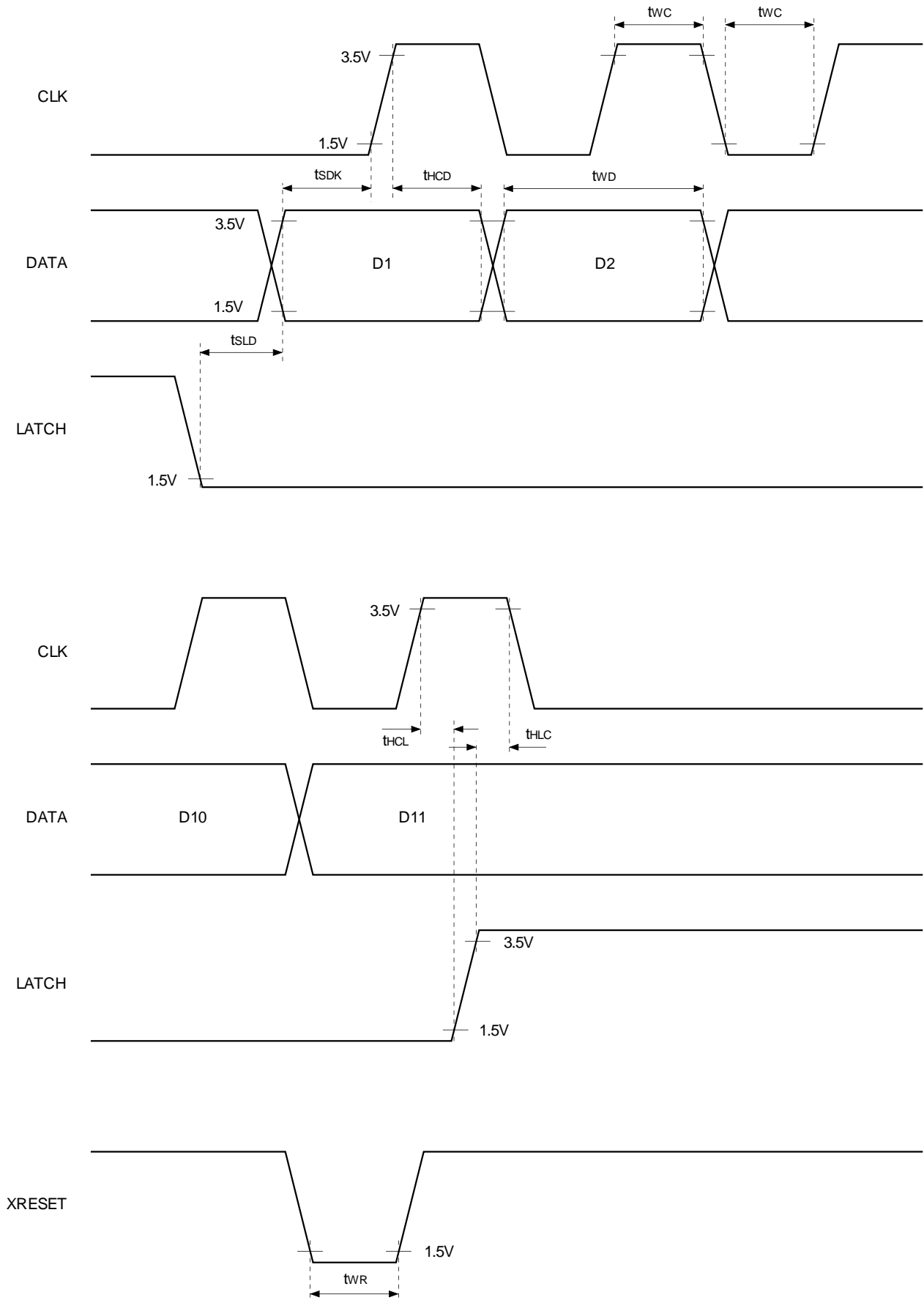
70 μ s – HS: EQ = 70 μ s – HIGH SPEED

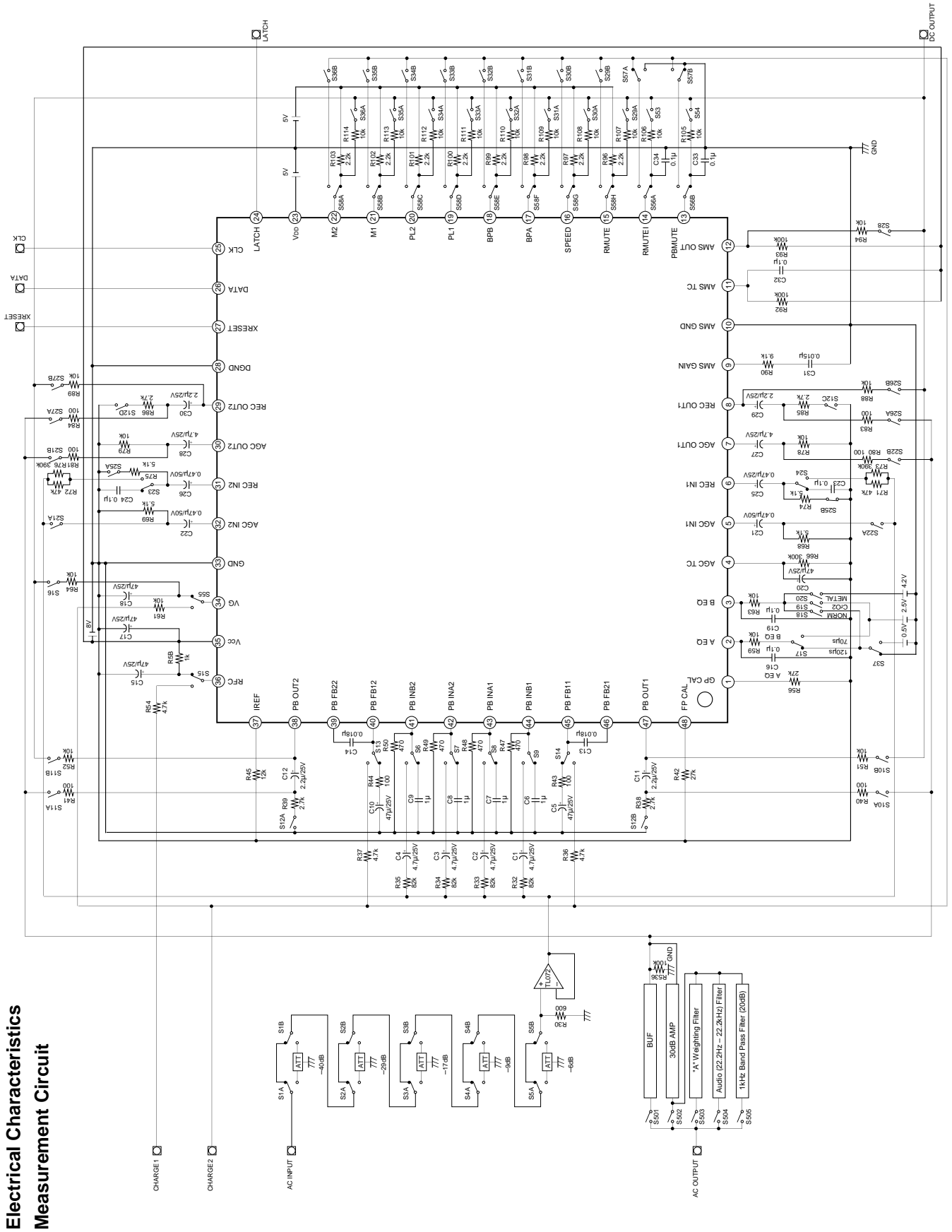
| Item | | Measurement conditions | Min. | Typ. | Max. | Unit |
|------------------------------------|------------------------------------|---|------|------|----------|---------------|
| 11-bit serial data interface block | Low level input voltage | V_{IL} (LATCH/CLK/DATA/XRESET) (Pins 24, 25, 26, 27) | 0.0 | — | 1.5 | V |
| | High level input voltage | V_{IH} (LATCH/CLK/DATA/XRESET) (Pins 24, 25, 26, 27) | 3.5 | — | V_{DD} | |
| | Low level output voltage | V_{OL} , $I_{OL} = 2\text{mA}$ (max) (Pins 15, 16, 17, 18, 19, 20, 21, 22) | 0.0 | — | 0.5 | |
| | High level output off leak current | I_{OZ} Leak current which flows to the output pin when I_{OZ} output is open; applied voltage is 10V. (Pins 15 to 22) | — | — | 1.0 | μA |
| | Maximum clock frequency | (1) f_{CK} | 500 | — | — | kHz |
| | Minimum clock pulse width | (2) t_{WC} | — | — | 1.0 | μs |
| | Minimum reset pulse width | (3) t_{WR} | — | — | 1.0 | |
| | Minimum data setup time | (4) t_{SDK} (DATA → CLK) | — | — | 1.0 | |
| | Minimum data hold time | (5) t_{HCD} (CLK → DATA) | — | — | 1.0 | |
| | Minimum data pulse width | (6) t_{WD} | — | — | 2.0 | |
| | Minimum latch setup time | (7) t_{SLD} (LATCH → DATA) | — | — | 1.0 | |
| | Minimum latch hold time | (8) t_{HCL} (CLK → LATCH) | — | — | 1.0 | |
| Minimum clock hold time | (9) t_{HLC} (LATCH → CLK) | — | — | 1.0 | | |

Note)

- V_{DD} is CPU supply voltage of 5.0V.
- V_{CC} is 10.0V for high level output off-leak current.
- The threshold levels of low level input voltage and high level input voltage depend on V_{DD} . Input level detection is done by comparison with $V_{DD}/2$. (Refer to “Equivalent circuit” of Pin Description.)

Timing Chart for 11-bit Serial Data Interface ($V_{DD} = 5.0V$)





Electrical Characteristics Measurement Circuit

1. System control mode

Playback and recording equalizer

(1) Playback equalizer (120 μ s/70 μ s)

| | | A-EQ (Pin 2) | | B-EQ (Pin 3) | |
|--|---|---------------------------|------------------------|---------------------------|------------------------|
| | | L | H | L | M/H |
| DECK-AB (serial data D10 (Pin 25)) | L | 120 μ s (DECK A) | 70 μ s (DECK A) | According to A-EQ control | |
| | H | According to B-EQ control | | 120 μ s (DECK B) | 70 μ s (DECK B) |

(2) Playback mute (Pin 13)

ON/OFF control is performed by 11-bit serial data interface D7 (Pin 26). A capacitor for setting the switching time constant is connected.

$$\text{Time constant} = 20\text{k}\Omega \times C$$

(3) Recording equalizer (Normal, CrO₂, Metal)

| B-EQ (Pin 3) | L | M | H |
|--------------|-----------------|----------------------------|-----------------|
| REC MODE | NORMAL (TYPE I) | CrO ₂ (TYPE II) | METAL (TYPE IV) |

(4) Recording mute (Pin 14)

ON/OFF control is performed by 11-bit serial data interface D11 (Pin 26). A fader function is achieved using a time constant circuit formed with the external capacitor and incorporated 20k Ω resistor.

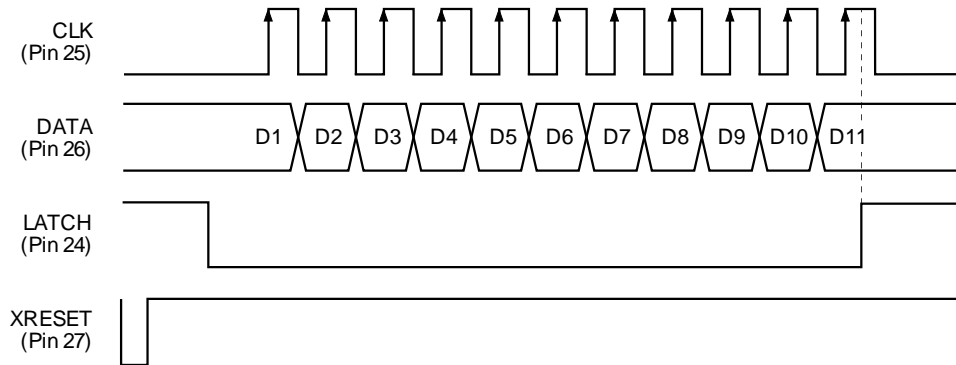
(5) FP CAL (Pin 48)

The standard resistor setting is 27k Ω , but when resistance value is larger, fo (Hz) is lower, and when resistance value is smaller, fo (Hz) is higher. (fo: high-band peak frequency)

(6) GP CAL (Pin 1)

The standard resistor setting is 27k Ω , but when resistance value is larger, high-band peak gain is larger, and when resistance value is smaller, high-band peak gain is smaller.

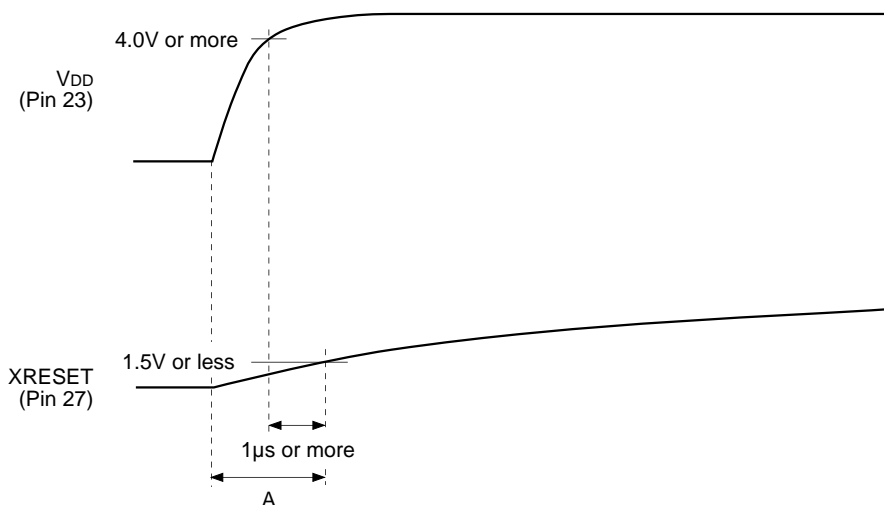
2. 11-bit serial data interface



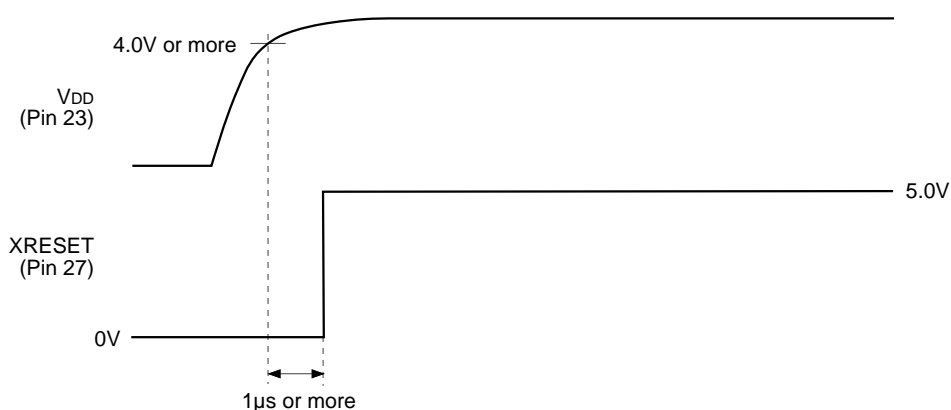
- The DATA signal is taken in at the rising edge of the CLK signal.
- The DATA signal is taken into the internal shift register when the LATCH signal is low. (Outputs (Pins 15 to 22) hold the previous value while the LATCH signal is low.)
- The internal shift register data is latched and output in parallel at the rising edge of the LATCH signal. (Internal shift register data is loaded while the LATCH signal is high.)
- The CLK signal of the 11th bit should fall after the LATCH signal rises.
- Reset is done when the XRESET pin is low. (asynchronous method)
Outputs (Pins 15 to 22) are all high (open) during reset.

| DATA (Pin 26) | Control signal | Output | | |
|------------------|----------------|------------|--------------------|-----------------------|
| | | Output pin | Input set at low | Input set at high |
| D1 | M2 | Pin 22 | Low | High (OPEN) |
| D2 | M1 | Pin 21 | Low | High (OPEN) |
| D3 | PL2 | Pin 20 | Low | High (OPEN) |
| D4 | PL1 | Pin 19 | Low | High (OPEN) |
| D5 | BPB | Pin 18 | Low | High (OPEN) |
| D6 | BPA | Pin 17 | Low | High (OPEN) |
| D7 | PB MUTE | — | Low mute OFF | High mute ON |
| D8 | AGC OFF | — | AGC function stops | AGC function operates |
| D9 | SPEED | Pin 16 | Low, normal speed | High (open) 1.7 |
| D10 | DECK AB | — | DECK A selected | DECK B selected |
| D11 | REC MUTE | Pin 15 | Low mute OFF | High (open) mute ON |

- Make sure that V_{DD} is 4.0V or more and XRESET is 1.5V or less, and 1 μ s or more when resetting by applying CR time constant to XRESET (Pin 27) and turning power ON.

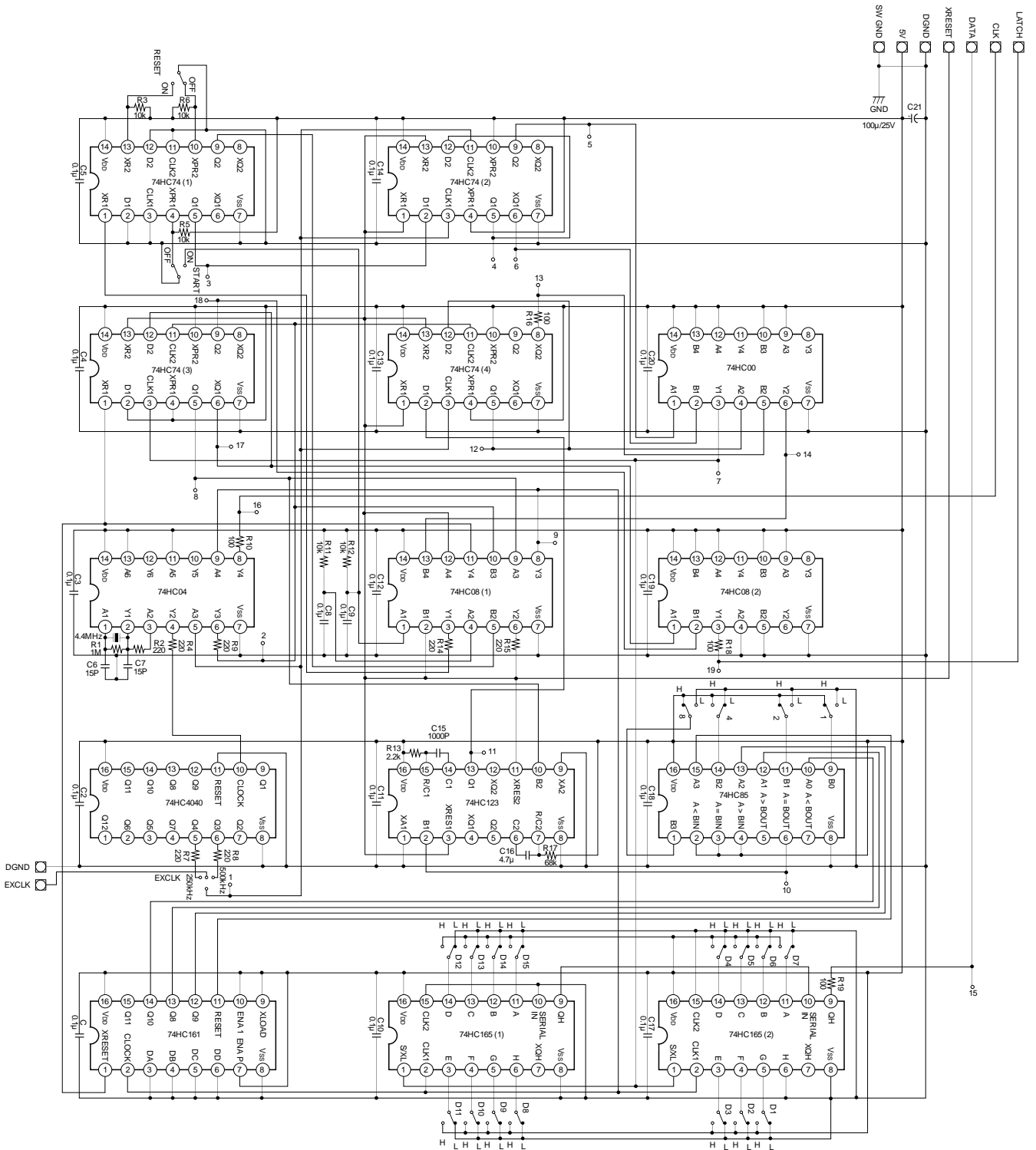


- XRESET (Pin 27) input level detection is done by comparison with $V_{DD}/2$. The level should be $V_{DD}/2 > XRESET$ during the interval A.
- For resetting with CPU when power is turned ON

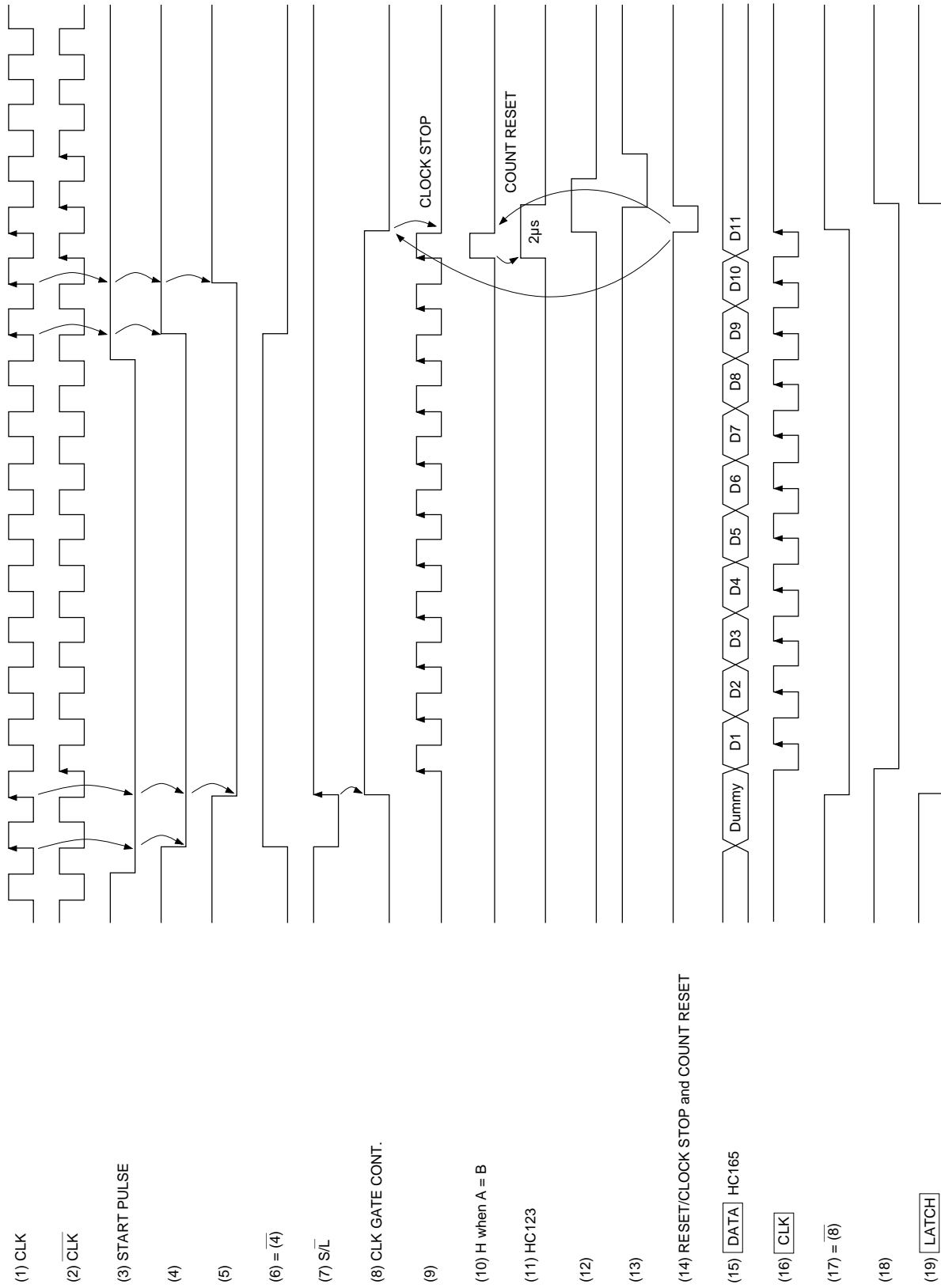


- Examples of AGC control during timer recording
 - (1) Resets when power is turned ON (AGC function operates).
 - (2) AGC is turned OFF after AGC inputs (Pins 5 and 32) rise. (External capacitor charge of AGC TC is discharged.)
 - (3) AGC is turned ON and timer recording begins.

Circuit Diagram for 11-bit Serial Data Transfer Evaluation Tool



Timing Chart for 11-bit Serial Data Transfer Evaluation Tool



3. AMS

(1) AMS output logic

| Detection status | Signal detection | No signal detection |
|------------------|------------------|---------------------|
| AMS OUT (Pin 12) | Low | High |

AMS OUT (Pin 12) is an open collector output pin. When a 3.9 kΩ resistor is connected to Vcc = 8V:
 Low: approximately 0.5V (I_{OL} = 2mA (max.))
 High: 8V

Fig. 1 shows the AMS block diagram.

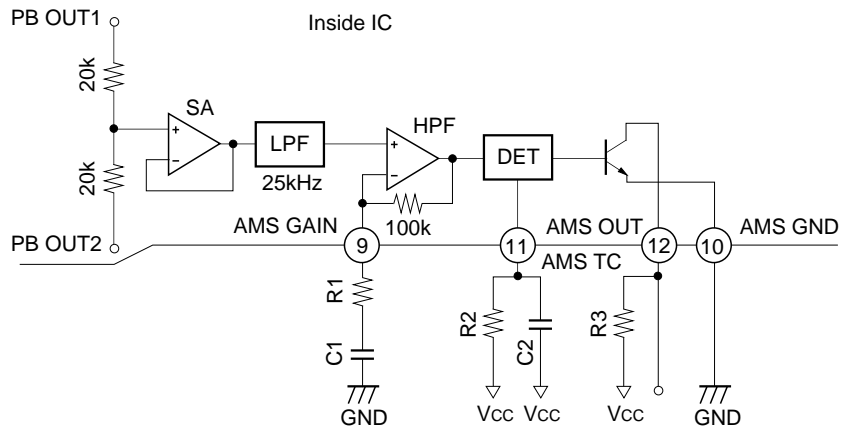


Fig. 1. AMS Block Diagram

Fig. 2 shows the frequency response of the signal output from HPF.

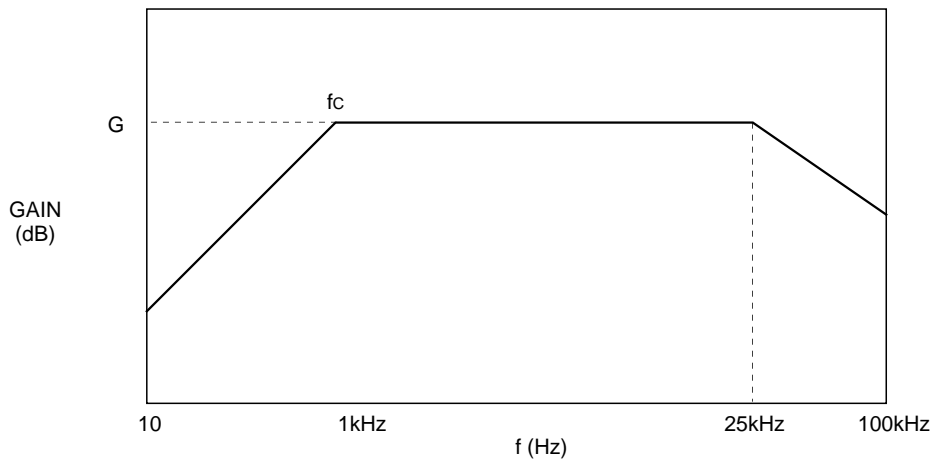


Fig. 2. Frequency Response

(2) AMS level setting

The AMS level is set by adjusting HPF gain and cut-off frequency with the external resistor and capacitor at Pin 9.

G and f_c in Fig. 2 are obtained from the following formula.

$$G = 20\log(1 + 100k/R1) \text{ [dB]} \dots\dots\dots (1)$$

$$f_c = 1 / (2 \cdot \pi \cdot C1 \cdot R1) \text{ [Hz]}$$

Full-wave rectifier is applied for the signal at DET.

Signal detection time is set by the time constant of Pin 11 external resistor and capacitor.

DET signal detection level:

$$= -7.5\text{dBm (typ.)}$$

$$= \text{playback equalizer reference output level} + \text{AMS level} + \text{HPF gain} \dots\dots\dots (2)$$

Playback equalizer reference output level of -21dBm is 0dB .

Ex.)

To set AMS level at -25dB , determine and set the constant for Pin 9 external resistor.

(Calculate assuming $\text{PBOUT1} = \text{PBOUT2}$)

First, get the required HPF gain from formula (2).

$$-7.5\text{dBm} = -21\text{dBm} + (-25\text{dB}) + \text{HPFgain},$$

so HPF gain = 38.5dB .

Next, get Pin 9 external resistance from formula (1).

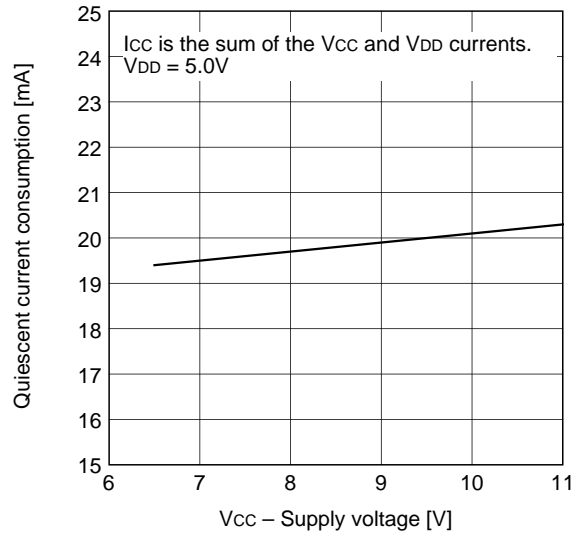
$$38.5\text{dB} = 20\log(1 + 100k / R1),$$

so $R1 \approx 1.2\text{k}\Omega$,

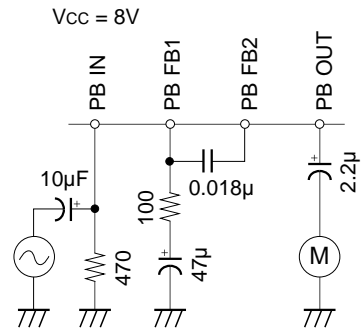
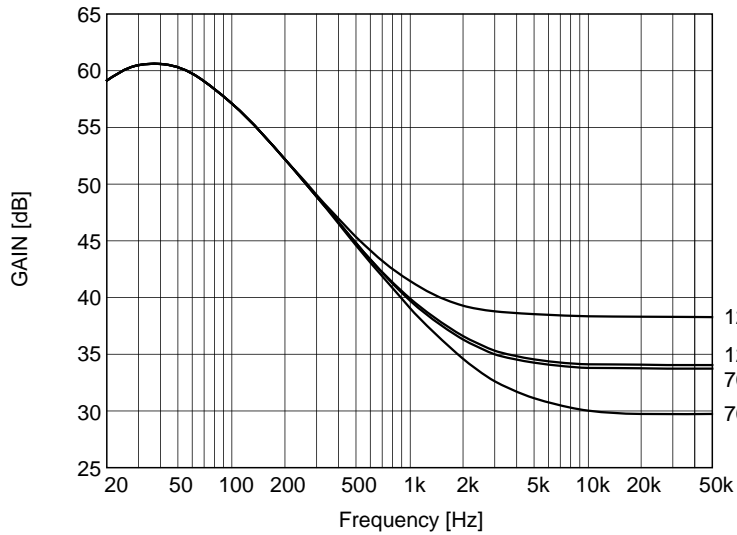
and external resistance is $1.2\text{k}\Omega$.

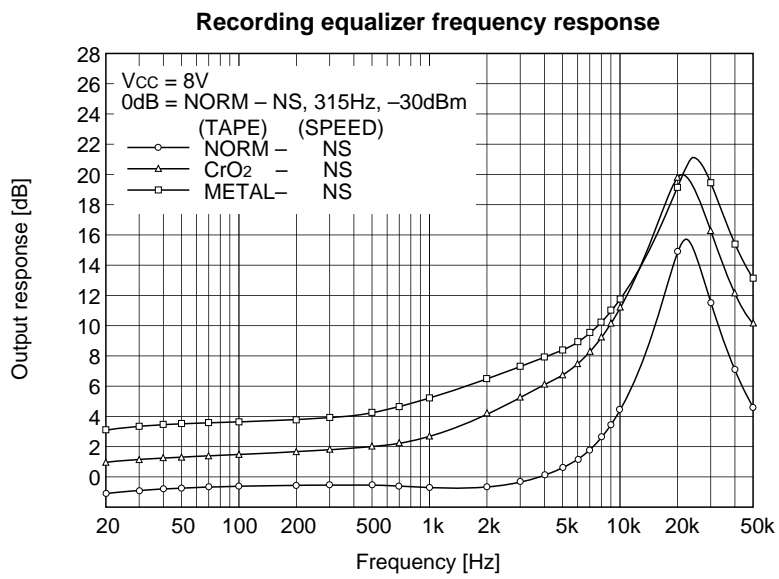
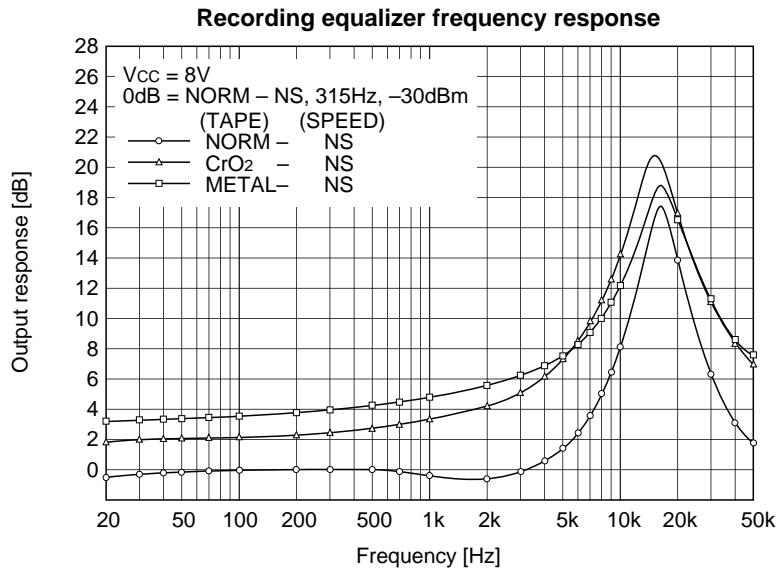
Example of Representative Characteristics

Quiescent current consumption vs. Supply voltage

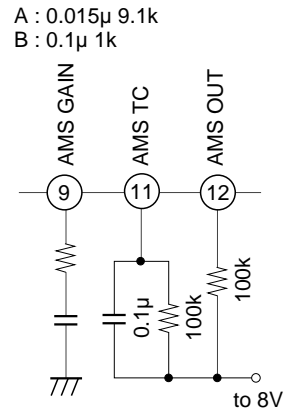
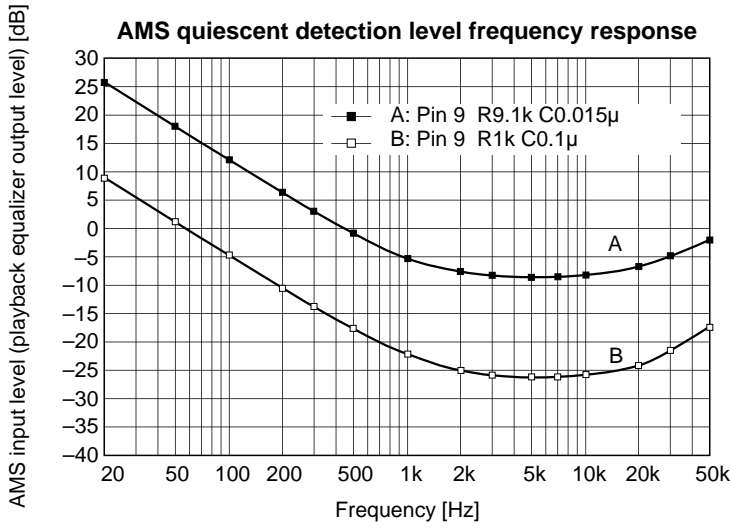


Playback equalizer frequency response

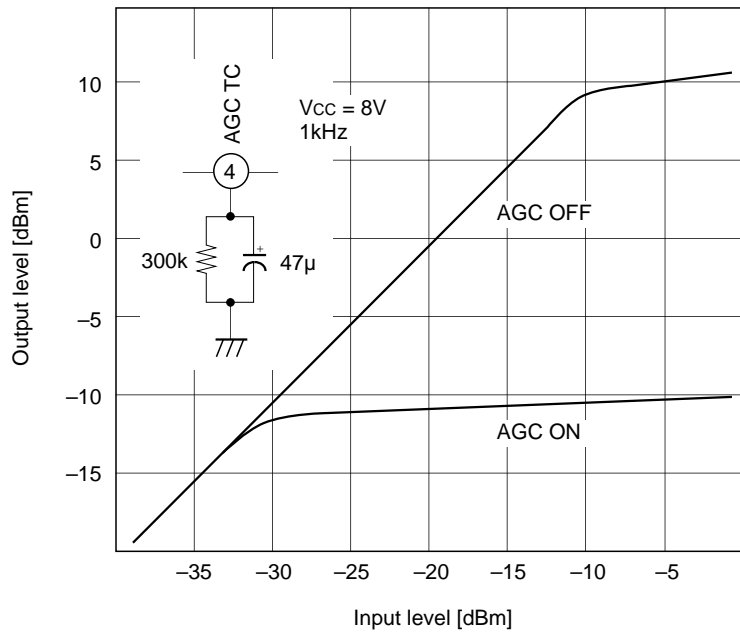




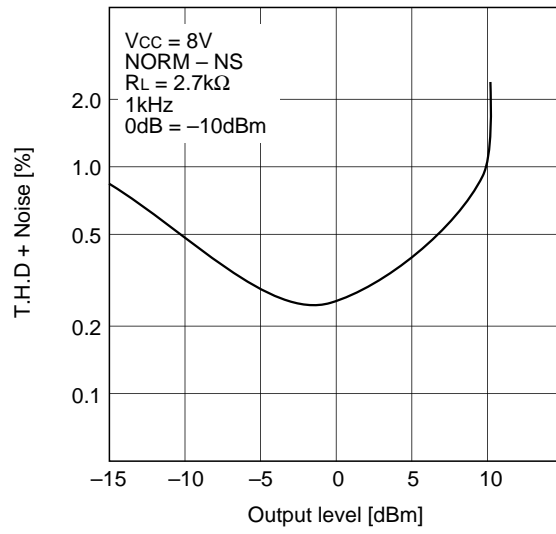
V_{CC} = 8V
 120μs - NS
 AMS OUT 8V
 0dB = -21dBm, 315Hz (playback equalizer reference output level)



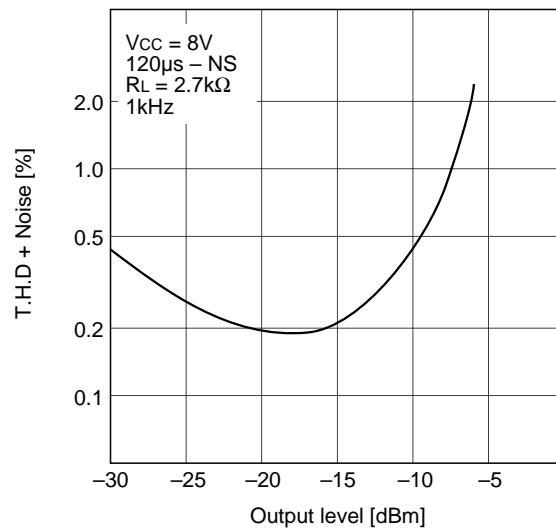
AGC output characteristics



Recording equalizer total harmonic distortion

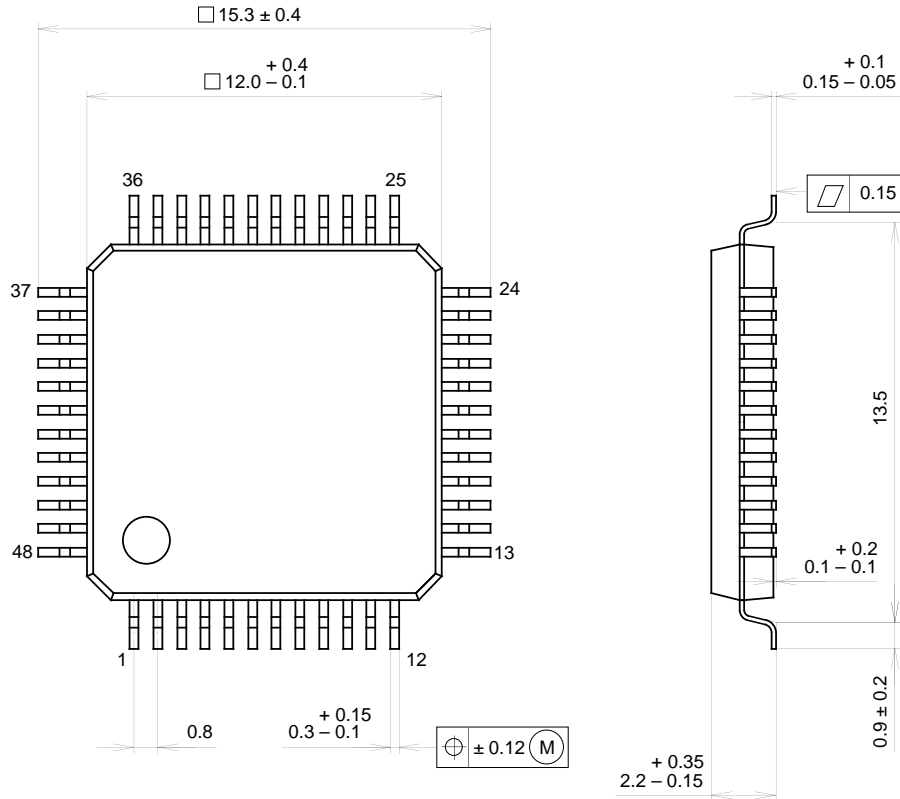


Playback equalizer total harmonic distortion



Package Outline Unit: mm

48PIN QFP (PLASTIC)



PACKAGE STRUCTURE

| | |
|------------|------------------|
| SONY CODE | QFP-48P-L04 |
| EIAJ CODE | *QFP048-P-1212-B |
| JEDEC CODE | _____ |

| | |
|------------------|----------------------------|
| PACKAGE MATERIAL | EPOXY RESIN |
| LEAD TREATMENT | SOLDER / PALLADIUM PLATING |
| LEAD MATERIAL | COPPER / 42 ALLOY |
| PACKAGE WEIGHT | 0.7g |

NOTE : PALLADIUM PLATING
 This product uses S-PdPPF (Sony Spec.-Palladium Pre-Plated Lead Frame).